

## Product Summary

$V_R$ (V)	$I_F$ (mA)	$V_F$ MAX (V) @ +25°C	$I_R$ MAX ( $\mu$ A) @ +25°C
70	1.0	0.41	0.1

## Description

70mA surface mount Schottky Barrier Diode in SOT23 package, offers low forward voltage drop and fast switching capability, designed with PN Junction Guard Ring for Transient and ESD Protection.

## Features and Benefits

- Low Turn-On Voltage
- Fast Switching
- PN Junction Guard Ring for Transient and ESD Protection
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

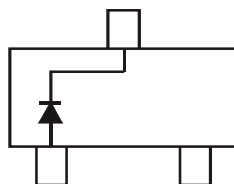
## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208  
Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe)
- Polarity: See Diagrams Below
- Weight: 0.008 grams (Approximate)

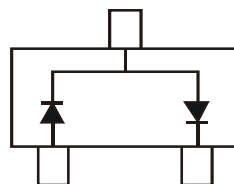
SOT23



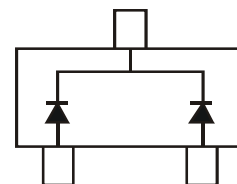
Top View



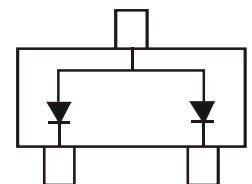
BAS70



BAS70-04



BAS70-05



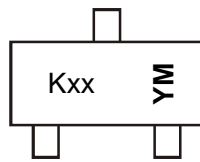
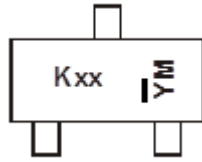
BAS70-06

## Ordering Information (Notes 5 and 6)

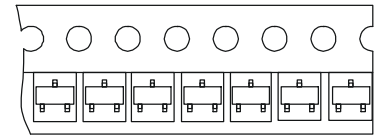
Part Number	Case	Packaging
BAS70-7-F	SOT23	3000/Tape & Reel
BAS70-04-7-F	SOT23	3000/Tape & Reel
BAS70-04Q-7-F	SOT23	3000/Tape & Reel
BAS70-04Q-13-F	SOT23	10000/Tape & Reel
BAS70-05-7-F	SOT23	3000/Tape & Reel
BAS70-06-7-F	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to <https://www.diodes.com/quality/>.
  5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
  6. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

## Marking Information



Kxx = Product Type Marking Code:  
 K73, K7C = BAS70  
 K74, K7D = BAS70-04&BAS70-04Q  
 K75, K7E = BAS70-05  
 K76, K7F = BAS70-06  
 YM & YM= Date Code Marking  
 Y = Year (ex: G = 2019)  
 M = Month (ex: 2 = Feb)



### Date Code Key

Year	2004	.....	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024
Code	R	.....	B	C	D	E	F	G	H	J	K	L	M

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	70	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	49	V
Maximum Forward Continuous Current (Note 7)	I <sub>FM</sub>	70	mA
Non-Repetitive Peak Forward Surge Current @ t ≤ 1.0s	I <sub>FSM</sub>	100	mA

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P <sub>D</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 7)	R <sub>θJA</sub>	625	°C/W
Operating Junction Temperature Range	T <sub>J</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V <sub>(BR)R</sub>	70	—	V	I <sub>R</sub> = 10μA
Forward Voltage	V <sub>F</sub>	—	410 1000	mV	t <sub>p</sub> < 300μs, I <sub>F</sub> = 1.0mA t <sub>p</sub> < 300μs, I <sub>F</sub> = 15mA
Reverse Current (Note 8)	I <sub>R</sub>	—	100	nA	t <sub>p</sub> < 300μs, V <sub>R</sub> = 50V
Total Capacitance	C <sub>T</sub>	—	2.0	pF	V <sub>R</sub> = 0V, f = 1.0MHz
Reverse Recovery Time	t <sub>RR</sub>	—	5.0	ns	I <sub>F</sub> = I <sub>R</sub> = 10mA to I <sub>R</sub> = 1.0mA, R <sub>L</sub> = 100Ω
Reverse Recovery Time (For BAS70-04 only)	t <sub>RR</sub>	—	2.0	ns	I <sub>F</sub> = I <sub>R</sub> = 10mA to I <sub>R</sub> = 1.0mA, R <sub>L</sub> = 100Ω

Notes: 7. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.  
 8. Short duration pulse test used to minimize self-heating effect.

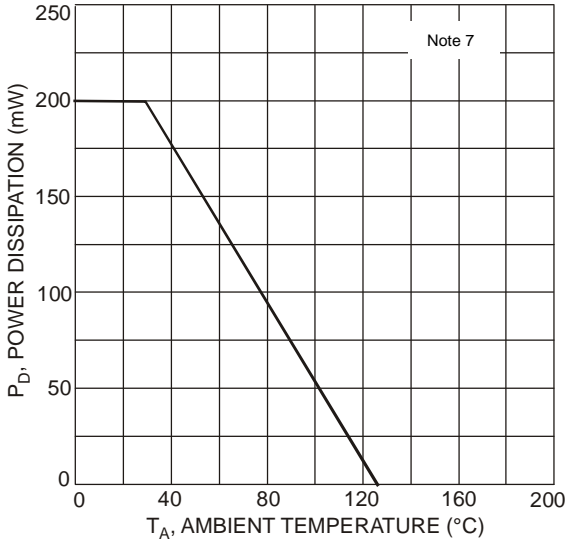


Figure 1 Power Derating Curve, Total Package

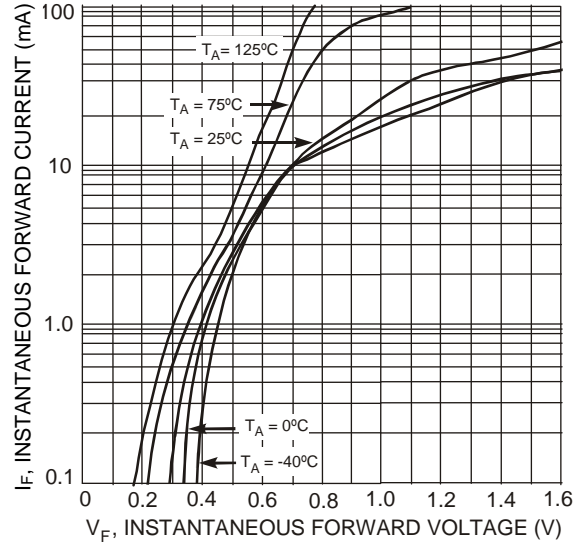


Figure 2 Typical Forward Characteristics

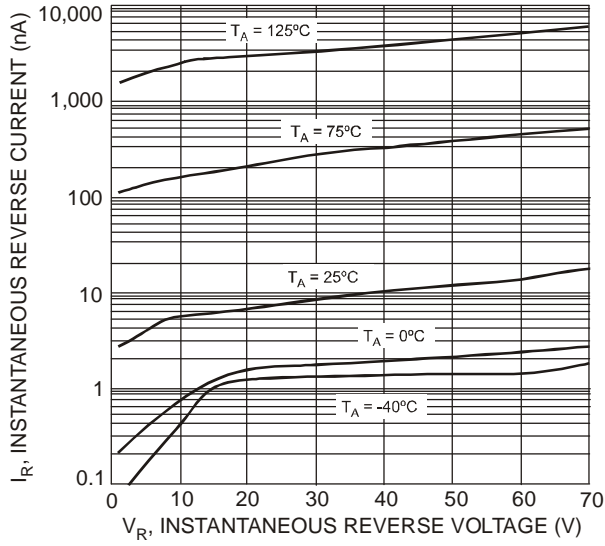


Figure 3 Typical Reverse Characteristics

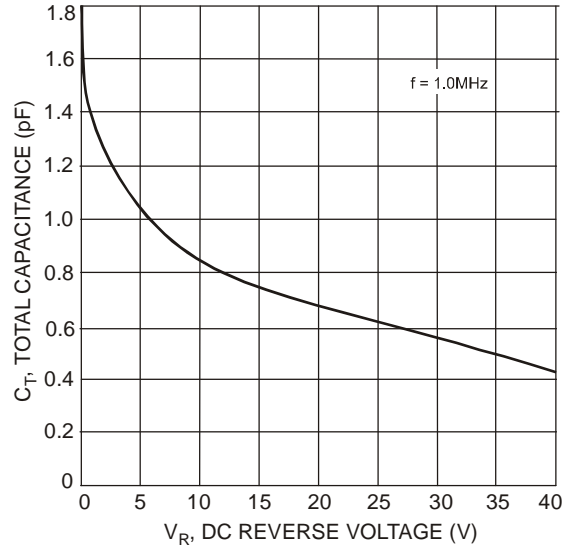
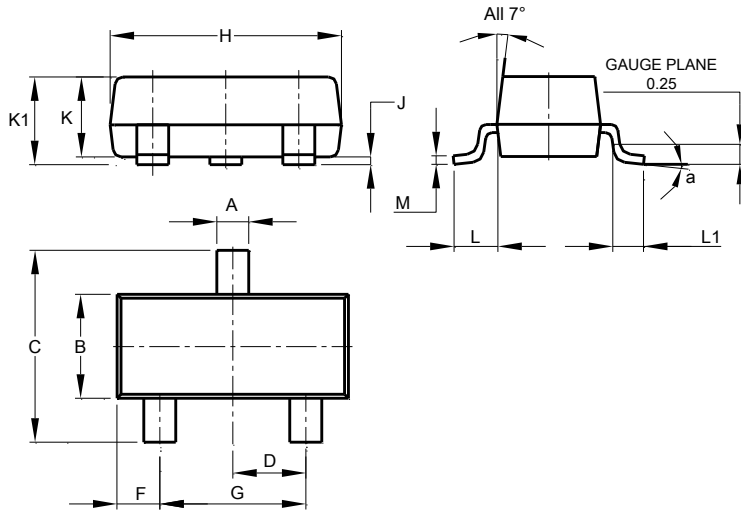


Figure 4 Total Capacitance vs. Reverse Voltage

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

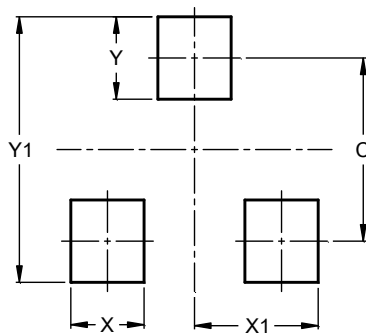


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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